

**SuperMOS – DFN1006-3L 20V  $V_{DSS}$ , 180m $\Omega$   $R_{DS(ON)}$ , N-channel MOSFET**

**1. Description**

The CJBA3134K-ES is N-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. Device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product CJBA3134K-ES is Pb-free.

**2. Features**

- 20V,  $R_{DS(ON)}$ =180m $\Omega$ (Typ.) @ $V_{GS}$ =4.5V
- $R_{DS(ON)}$ =260m $\Omega$ (Typ.) @ $V_{GS}$ =2.5V
- $R_{DS(ON)}$ =415m $\Omega$ (Typ.) @ $V_{GS}$ =1.8V
- High density cell design for low  $R_{DS(on)}$
- Material: Halogen free
- Reliable and rugged
- Avalanche Rated
- Low leakage current


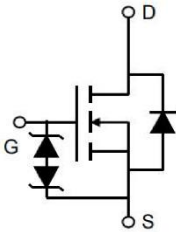
**3. Applications**

- PWM applications
- Load switch
- Power management in portable/desktop PCs
- DC/DC conversion

**4. Ordering Information**

Part Number	Package	Marking	Material	Packing	Quantity per reel	Flammability Rating	Reel Size
CJBA3134K-ES	DFN1006-3L	34KE	Halogen free	Tape & Reel	10K PCS	UL 94V-0	7 inches

**5. Pin Configuration and Functions**

Pin	Function	Outline	Circuit Diagram
1	Gate		
2	Source		
3	Drain		

## 6. Specification

### Absolute Maximum Rating & Thermal Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	$BV_{DSS}$	20	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Continuous Drain Current	$I_D$	$T_A=25^\circ\text{C}$	0.7
		$T_A=75^\circ\text{C}$	0.54
Maximum Power Dissipation	$P_D$	0.22	W
Pulsed Drain Current	$I_{DM}$	2.8	A
Operating Junction Temperature	$T_J$	150	$^\circ\text{C}$
Lead Temperature	$T_L$	260	$^\circ\text{C}$
Storage Temperature Range	$T_{stg}$	-55 to 150	$^\circ\text{C}$

### Thermal resistance ratings

Single Operation					
Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance	$t \leq 10\text{s}$	$R_{\theta JA}$		556	$^\circ\text{C/W}$

## Electrical Characteristics

At TA = 25°C unless otherwise specified

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
<b>OFF CHARACTERISTICS</b>						
Drain-to-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	20			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=20V, V_{GS}=0V$			1	$\mu A$
Gate-to-source Leakage Current	$I_{GSS}$	$V_{DS}=0V, V_{GS}=\pm 10V$			$\pm 10$	$\mu A$
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	0.35	0.75	1.1	V
Drain-to-source On-resistance	$R_{DS(on)}$	$V_{GS}=4.5V, I_D=0.6A$		180	300	m $\Omega$
		$V_{GS}=2.5V, I_D=0.5A$		260	350	
		$V_{GS}=1.8V, I_D=0.2A$		415	700	
<b>CHARGES, CAPACITANCES AND GATE RESISTANCE</b>						
Input Capacitance	$C_{ISS}$	$V_{GS}=0V, f=1MHz,$ $V_{DS}=10V$		56		pF
Output Capacitance	$C_{OSS}$			20		
Reverse Transfer Capacitance	$C_{RSS}$			2.5		
Total Gate Charge	$Q_{G(TOT)}$	$V_{GS}=4.5V, V_{DS}=10V,$ $I_D=0.5A$		1		nC
Gate-to-Source Charge	$Q_{GS}$			0.28		
Gate-to-Drain Charge	$Q_{GD}$			0.22		
<b>SWITCHING CHARACTERISTICS</b>						
Turn-On Delay Time	$t_{d(ON)}$	$V_{GS}=4.5V, V_{DS}=10V,$ $I_D=0.5A, R_G=3\Omega$		2		ns
Rise Time	$t_r$			18.8		
Turn-Off Delay Time	$t_{d(OFF)}$			10		
Fall Time	$t_f$			25		
<b>BODY DIODE CHARACTERISTICS</b>						
Forward Voltage	$V_{SD}$	$V_{GS}=0V, I_S=0.7A$			1.2	V

7. Typical Characteristic

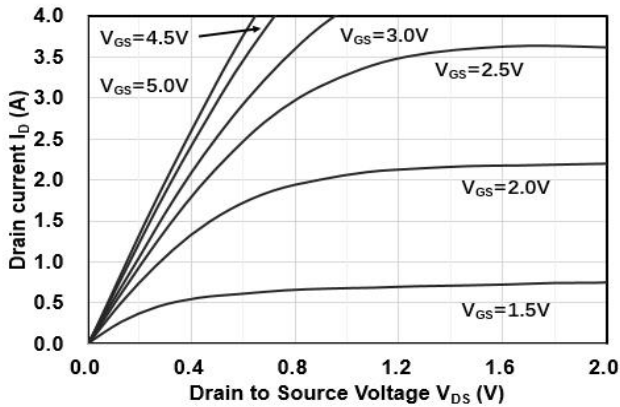


Figure1. Output Characteristics

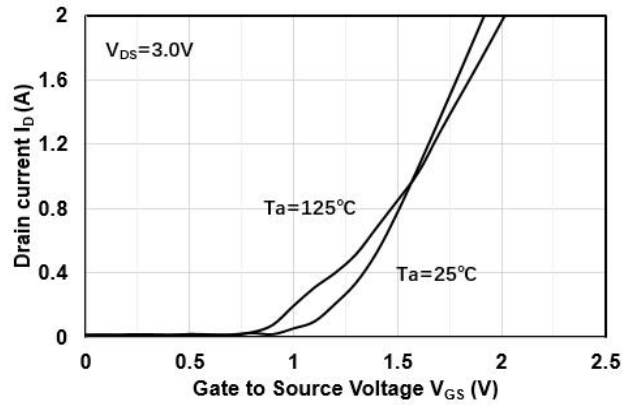


Figure2. Transfer Characteristics

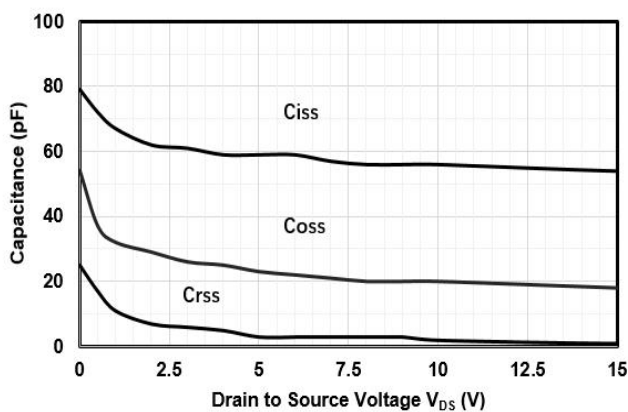


Figure3. Capacitance Characteristics

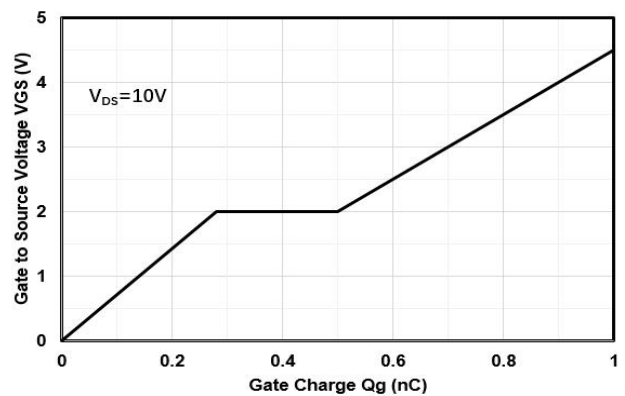


Figure4. Gate Charge

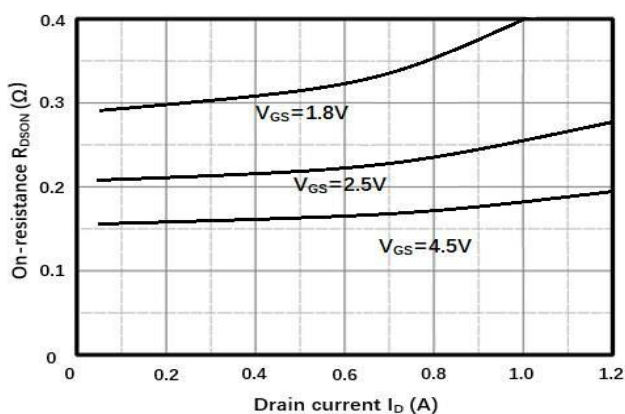


Figure5. Drain-Source on Resistance

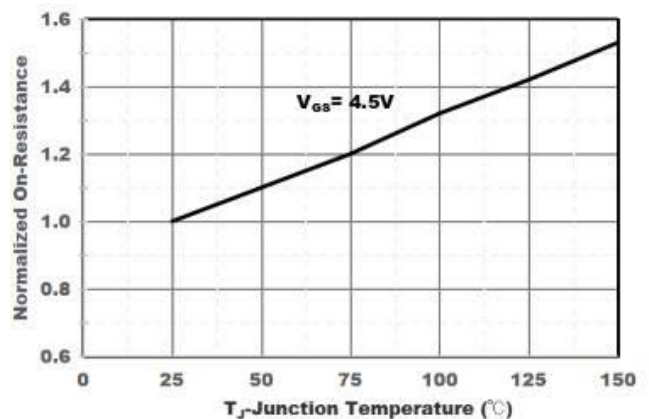


Figure6. Drain-Source on Resistance

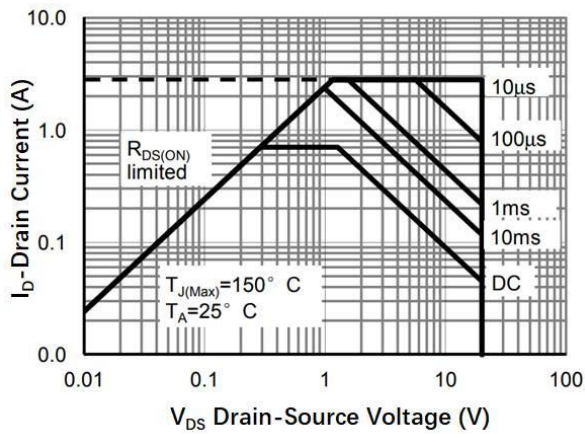


Figure7. Safe Operation Area

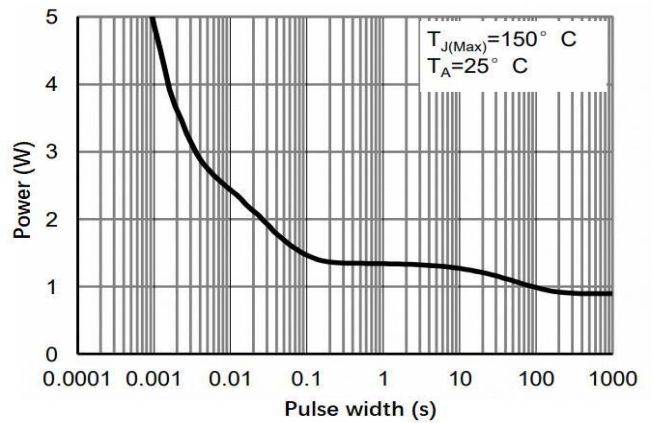


Figure8. Pulse Power Rating Junction-to Ambient

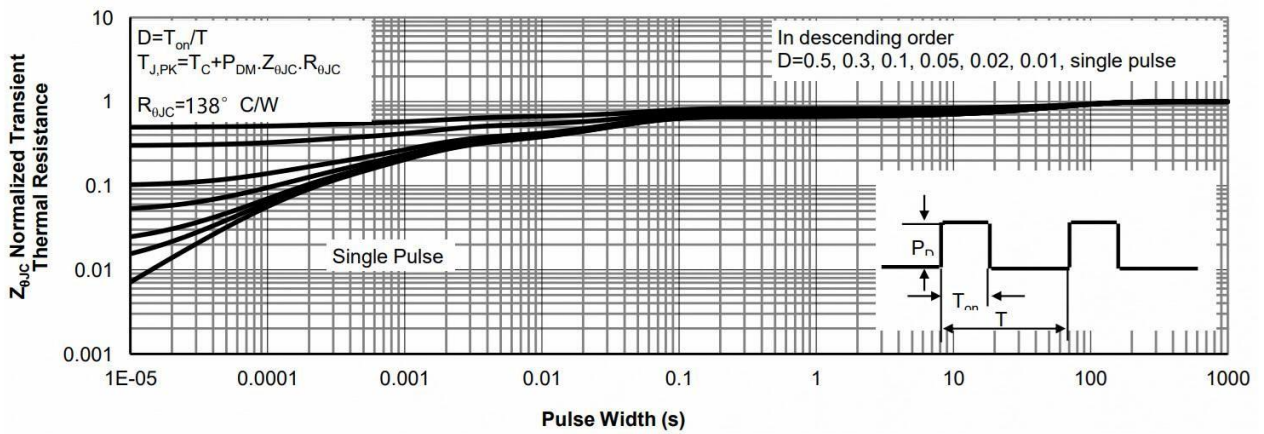
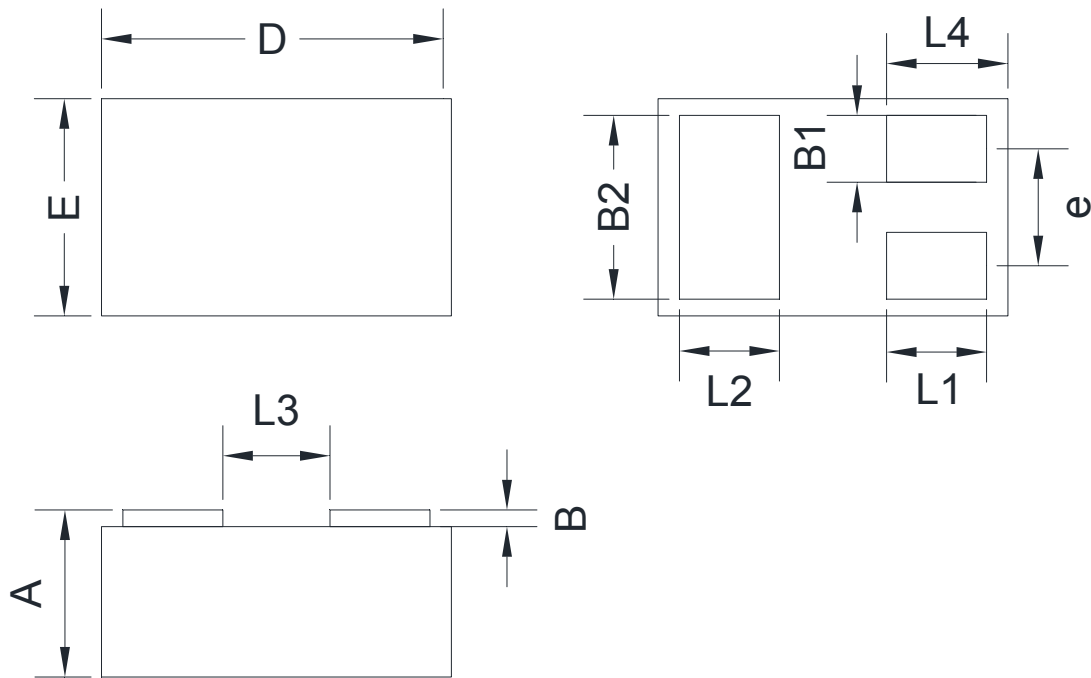


Figure9. Normalized Maximum Transient Thermal Impedance

8. Dimension (DFN1006-3L)



Symbol	Millimeters		Symbol	Millimeters	
	Min	Max		Min	Max
A	0.40	0.50	e	0.35	
B	0.00	0.05	L1	0.20	0.30
B1	0.10	0.20	L2	0.20	0.30
B2	0.45	0.55	L3	0.39	
D	0.90	1.05	L4	0.25	0.35
E	0.50	0.65			

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